



Supercritical drying of cementitious materials

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ABSTRACT

Techniques to characterize the microstructure of hydrated cement require dried materials. However, the microstructure of hydrated products is significantly altered by high capillary forces during drying when using the conventional drying methods. To avoid drying stresses when preparing samples, we have employed supercritical drying (SCD) which has been used for decades to prepare aerogels that undergo no shrinkage during drying, but has rarely been used for cementitious materials. The pore solution is first replaced with isopropanol, and then with trifluoromethane (R23). The temperature and pressure are raised above the critical point, where no menisci or capillary pressure can exist; therefore, the dried samples are free of artifacts created by stresses. Images from scanning electron microscope show less compact morphology for supercritically dried samples than that dried by conventional methods, while BET surface areas of SCD samples are very close to samples dried by the isopropanol replacement method. This can be explained by the fact that isopropanol and supercritical fluid enter the micropores and block them. The nature of the chemical interactions of isopropanol and R23 with cement pastes are still not clear, but no reaction products were identified in the present study.

1. Introduction

Pore structure of cementitious materials is a decisive factor that can be used to determine materials properties, such as permeability, and also can help us to understand the process of nucleation and growth of hydration products. To characterize the pore structure and the morphology of calcium silicate hydrate (C-S-H), various techniques have been used, such as scanning electron microscopy (SEM), mercury intrusion porosimetry (MIP), and gas (nitrogen or water vapor) adsorption. These techniques require dried samples, and unfortunately the pore structure is significantly affected by drying.

Drying can remove water, classified as evaporable water, from two types of pores. Capillary pores are larger and hold water in saturated conditions but lose water on exposure to air (at ambient relative humidity). Gel pores are nanometer-size pores (< 10 nm) [1] and water present in gel pores is more strongly bound than capillary water, so that ambient relative humidity (RH) may not be able to remove it; reduced pressure or elevated temperature is required. No matter what drying method is used, the ideal condition is that no water is left in capillary and gel pores after drying. The residual evaporable water in the material interferes with the characterization of the pore structure. However, in most drying methods, the interface between liquid water and air creates capillary pressure. According to the Laplace equation, capillary pressure increases with the decrease of pore size ($P_c \propto 1/r$). This means that the removal of gel-pore water can cause high capillary

pressure so the damage to gel pores is more significant than that to capillary pores. The damage is mainly from the shrinkage of pores and rearrangement of particles. Various drying methods used to minimize the influence of drying on the pore structure have been extensively reviewed in the literature [2,3].

The process of taking water out the porous media can be achieved in three ways according to the phases of water (Fig. 1). Direct drying (e.g., flowing N_2 drying, oven drying and vacuum drying) lets liquid water directly evaporate to the vapor phase. The vapor pressure of water is at the saturation level at the surface of the body, and the rate of evaporation is controlled by diffusion through a boundary layer [4,5]. The flowing N_2 creates the zero-humidity environment to force liquid water to evaporate, and the higher the velocity of the nitrogen, the thinner the boundary layer, which accelerates the kinetics of drying. Oven drying, either at 60 °C or 105 °C, speeds up the evaporation by raising the vapor pressure and diffusivity of the water vapor, but usually does not permit strong convection. Oven-drying above 40 °C may lead to dehydration and rearrangement of hydration products [6], and consequently more coarsening of pore structure than other methods. Vacuum drying is also an acceleration process which decreases the surrounding vapor pressure, but it is slow because the absence of convection results in a thick boundary layer. Direct drying methods do not eliminate or reduce capillary pressure (except for the small effect of temperature on surface tension), so materials still suffer high capillary forces.

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